AKU342Bottom port, Analog MEMS Microphone





Data Sheet

Part number(s) AKU342

Package type 6-pin LGA bottom port

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Notes Specifications are subject to change without notice.

Product photos and pictures are for illustration purposes only and may differ

from the real product's appearance.



Data Sheet

AKU342 Analog, HD Voice MEMS Microphone

Key Features

- Analog output, omni-directional microphone
- Excellent SNR: 63dB
- Tight sensitivity tolerance: -38dB +/- 2
- Flat frequency response for super-wideband audio
- Package immune to RF/EM interference
- Industry-standard SMT footprint
- Lead-free, RoHS compliant, and Halogen Free in accordance with IEC61249-2-21
- Thin bottom port package: 2.95 x 3.76 x 1.00 mm³

Typical Applications

- Smartphones and mobile phones which require high quality acoustic performance in a small form factor microphone
- Multi-mic applications and noise cancellation algorithms which benefit from microphones with tightly matched sensitivity and phase
- Products designed to capture super-wideband audio that require a microphone with less than 5dB variation in frequency response from 50Hz-14kHz
- Other small, thin consumer electronic devices using more than one microphone

General Description

AKU342 is a surface-mountable analog-output MEMS microphone ideal for use in mobile consumer applications which require HD Voice quality audio. Designed specifically to meet the demanding requirements of mobile handset OEMs, AKU342 offers excellent acoustic performance with 63dB signal-to-noise ratio (SNR) and tight sensitivity matching of just +/-2dB between microphones.

AKU342 is available in an industry standard package footprint of 2.95mm x 3.76mm x 1.00mm.



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1. ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD} to GND 5.5V

ESD Tolerance

Human Body Model 2000V Machine Model 200V

Storage Temperature Range -40°C to 105°C

2. STANDARD OPERATING CONDITIONS

Operating Temperature Range -40°C to 85°C Supply Voltage (V_{DD}) 1.6V to 3.6V

3. ELECTRICAL AND ACOUSTIC SPECIFICATIONS

Unless otherwise noted, test conditions are:

 $V_{DD} = 2.0V$ Ta = 25°C RH = 50%

Parameter Test Conditions		Min.	Тур.	Max.	Unit	
Directivity		Om	Omni-directional			
Signal to Noise Ratio (SNR)	f _{in} =1 kHz, A-weighted, 20Hz-10kHz	63			dB	
Low Frequency Corner	-3dB from 1kHz sensitivity value	IB from 1kHz sensitivity value 60		Hz		
Upper Frequency Corner	+3dB from 1kHz sensitivity value		10		kHz	
Sensitivity ¹	1kHz, 94 dB SPL	-40	-38	-36	dBV/Pa	
Total Harmonic Distortion (THD) ¹	@ 94dB SPL, f _{in} =1 kHz			1	%	
	@ 114dB SPL, f _{in} =1 kHz			5		
Power Supply Rejection Ratio (PSRR)	100mVpp, f=217Hz	60			dB	
Current Consumption ¹	No load			300	μΑ	
Output Impedance				200	Ω	
Sensitivity loss across voltage	Change in sensitivity over 3.6 to 1.6V		0		dB	
Part-to-part phase matching	From nominal @ 1kHz			±10	0	
Polarity	Increasing sound pressure	Increasing output volta		oltage		

Note 1: Parameter 100% tested

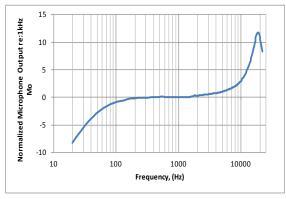


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4. DEVICE CHARACTERISTICS

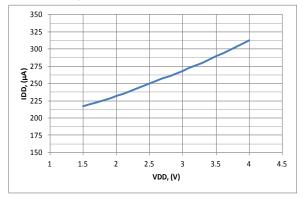
4.1 Frequency Response

(Measured frequency response normalized to 1kHz)



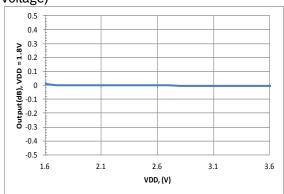
4.2 I_{DD} vs. V_{DD}

(Measured current consumption relative to supply voltage)



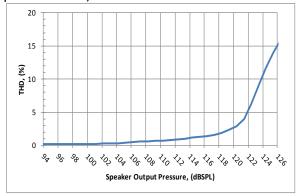
4.3 Sensitivity vs. VDD

(Measured sensitivity changes relative to supply voltage)



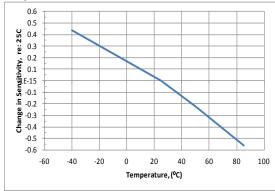
4.4 Total Harmonic Distortion

(Measured THD relative to speaker output pressure level)



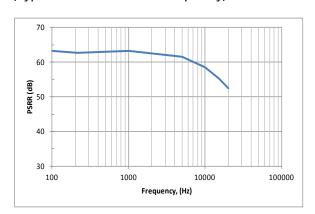
4.5 Sensitivity vs. Temperature

(Typical sensitivity changes relative to temperature)



4.6 PSRR vs. Frequency

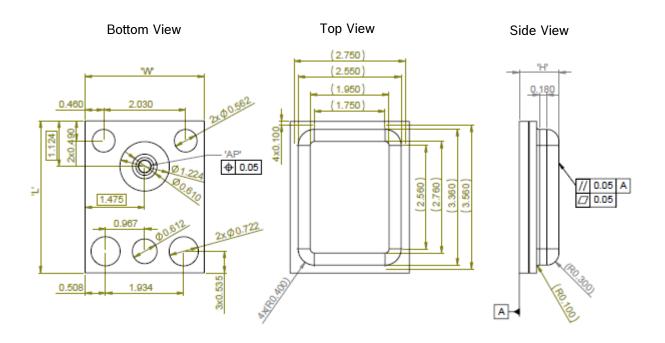
(Typical PSRR relative to frequency)





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5. MECHANICAL SPECIFICATIONS



Dimension	Tolerance	Units
3.76	± 0.10	mm
2.95	± 0.10	mm
1.00	± 0.10	mm
0.30	± 0.03	mm
Top/Bottom	± 0.05	mm
	3.76 2.95 1.00 0.30	3.76 ± 0.10 2.95 ± 0.10 1.00 ± 0.10 0.30 ± 0.03

 $\begin{array}{c} \text{All dimensions in mm} \\ \text{Tolerance} \pm 0.05 \text{mm unless otherwise specified} \end{array}$

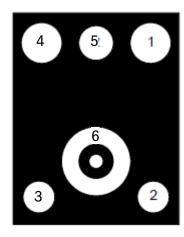


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6. PIN-OUT AND CONNECTION DIAGRAMS

6.1 Pin-Out

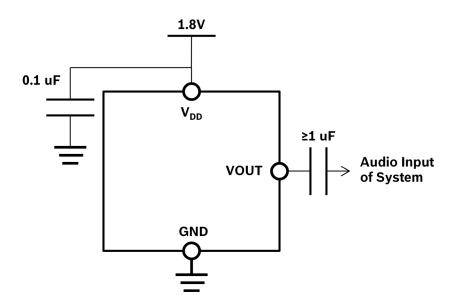
(As viewed from bottom of package)



Pin	Name	Function		
1	OUT	Analog output voltage		
2	GND	Ground		
3	NC/GND ¹	No Connect or Ground		
4	V_{DD}	Power supply voltage for microphone		
5, 6	GND	Ground		

Note 1: Pin 2 must be Ground. Pin 3 can be left as No Connect or tied to Ground.

6.2 Typical Application Schematic



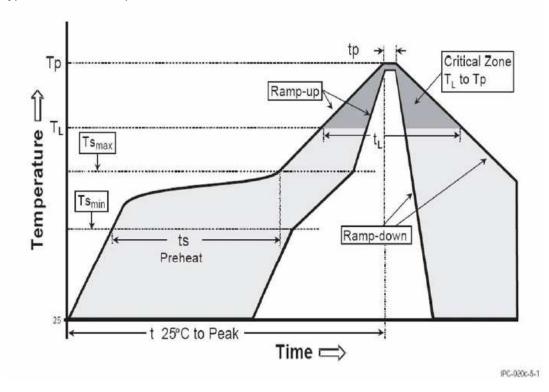


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7. MANUFACTURING NOTES

7.1 Solder Reflow

Typical solder reflow profile



Average ramp-up rate	Max. 3° C/s
Time t _s between Ts _{min} (150° C)and Ts _{max} ° C	60 – 120 s
Time t_L above liquidous temperature T_L (217° C)	60 – 90 s
Peak temperature T _P	max. 260° C
Time t _P at T _P	max. 20 s
Average ramp-down rate	max. 6° C/s

Please refer to AN60-Handling, Soldering, and Mounting Instructions for more detailed information and precautions.



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7.2. Microphone Handling

Although the microphone may not appear damaged immediately due to inappropriate handling, there can be long term effects that affect the lifetime of the component.

Rule of thumb: The microphone is an artificial ear so treat it like your own ear.

- Do not blow air into the acoustic port of the microphone for any reason. Do not shoot it with pressurized air
 - e.g. when cleaning the board or other components on the same board
- Do not apply vacuum to the microphone
 - See section 5.0 for pick & place location
- Do not insert liquids
 - If populated circuit boards are washed, the microphone must be protected
- Do not insert dust
 - The production facilities must be clean
 - e.g. if PCB routing/sawing is done close to the microphone after SMT assembly and reflow
- Do not insert any objects
 - If assembly or rework is done manually, care must be taken that the tools cannot enter the microphone sound port
 - It is best to choose tool size so that it does not fit through the sound port of the microphone
- Do not cover the acoustic port with tape when heating during assembly or reflow
- Do not apply extreme mechanical stresses on the microphone, including mechanical shocks above 10kG or compression of the microphone package.
- After a bottom port microphone has been assembled on a circuit board, protect the sound port (now on the other side of the board) from dust, liquids, and other foreign materials as well as any tools and pressurized air.

ESD Handling Procedures



Follow CMOS handling procedures with Akustica MEMS microphones. Handle the microphone with proper workplace grounding to include wrist straps and ionized airflow over open trays and reels of microphones. Do not hot-swap/hot-plug during testing. Device pins have ESD ratings of 2kV/200V for HBM/MM respectively.

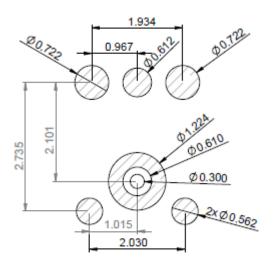


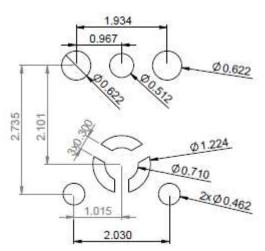
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7.3 PCB Land Pattern and Stencil Pattern

PCB Land Pattern Layout

Suggested Solder Paste Stencil Pattern Layout







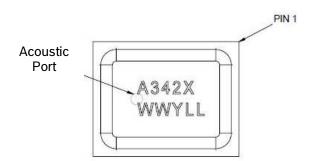
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8. RELIABILITY SPECIFICATIONS

The microphone sensitivity after stress must deviate by no more than 3 dB from the initial value.

	Test	Test Condition
1	Cold Temp Operation	Temperature = -40C, 1000 hours (with bias)
2	Hot Temp Operation	Temperature = 105C, 1000 hours (with bias)
3	Humidity Operation	Temperature = 85C, RH = 85%, 1000 hours (with bias)
4	Cold Temp Storage	Temperature = -40C, 1000 hours (without bias)
5	Hot Temp Storage	Temperature = 105C, 1000 hours (without bias)
6	Humidity Storage	Temperature = 85C, RH = 85%, 1000 hours (without bias)
7	Thermal Cycle	100 Cycles, -40 to +125C, 15min soaks, <30sec ramps
8	Vibration	Sinusoidal Vibration, 20-2000Hz, 4min sweeps, 16min along each of 3 axis, amplitude 3 limits of 20G and 0.06"
9	Mechanical Shock	10,000 G shocks, 5 impacts along each of 6 axes
10	Drop Test	Using 150gm aluminum fixture, 3 drops along each of 6 axes (total 18 drops) from 1.5m height onto concrete drop surface.
11	ESD (HBM)	+/-2000V, 1 discharge for each polarity, 11 pin combinations, 22 total discharges per microphone
12	ESD (MM)	+/- 200V, 1 discharge for each polarity, 11 pin combinations, 22 total discharges per microphone
13	ESD	+/- 8kV, contact discharge to lid with DUT grounded
14	Moisture Sensitivity Level	24 hour bake at 125C, followed by 168 hours at 85C, 85%RH, followed by 3 passes solder reflow (MSL Level 1)

9. PART MARKING INFORMATION



Line 1: A342X (A=Akustica, Part Code=342, X=Assembly Facility)

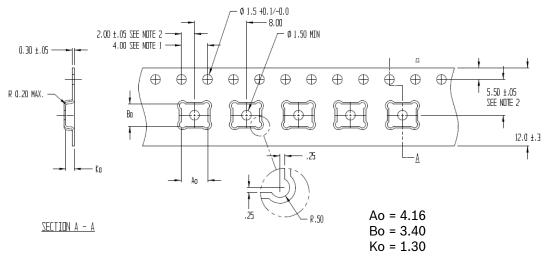
Line 2: WWYLL (WW= Work Week, Y= Year, LL= Lot Number Processed During Work Week)



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10. PACKAGING INFORMATION

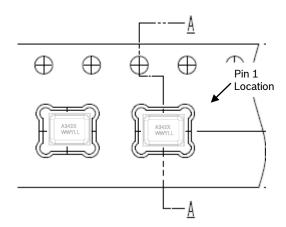
10.1 Tape Specification



Notes:

- 1. 10 sprocket hole pitch cumulative tolerance +/-0.2
- 2. Camber in compliance with EIA-481
- 3. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole
- 4. Ao and Bo are calculated on a plane at a distance of "R" above the bottom of the pocket.

10.2 Component Orientation





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11. ORDERING INFORMATION

Part Number	Order Number	Part Code	Package	Shipping Method	Standard Quantity
AKU342	02730A0003.C00	A342	6-Pad LGA	13" Reel	5,700

For more information, sample requests or to place an order, please contact Akustica.

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